



US03-001

Serial No. 10/802,563

Please do not enter
2/8/2008

January 29, 2008

/Su Kim/

O: Commissioner for Patents

P.O. Box 1450

VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/802,563 03/17/04

Hong Yu Yu et al

"A THERMAL ROBUST SEMICONDUCTOR
DEVICE USING HFN AS METAL GATE
ELECTRODE AND THE MANUFACTURING
PROCESS THEREOF"

Grp. Art Unit: 2823

SU C. KIM

RESPONSE FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Final Office Action dated November 1, 2007, please amend the above-identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on January 30, 2008.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date

1/30/08

Entered
with
file
RCE
OKON

3/18/08